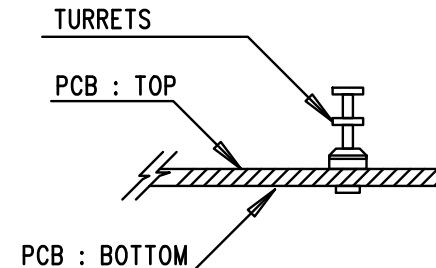


NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
MAXIMUM SOLDER TEMPERATURE IS 240 DEG C.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE
BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP
TO ANY BOARD.

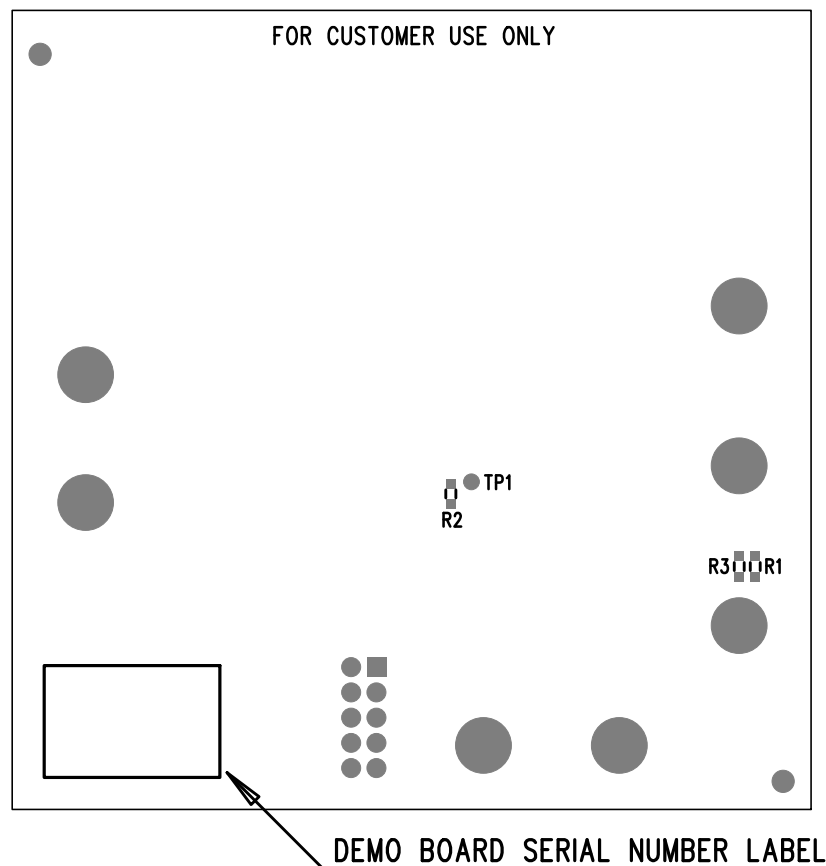



1630 MCCARTHY BLVD
MILPITAS, CA 95035
PH: (408)432-1900
www.linear.com
LTC CONFIDENTIAL-
FOR CUSTOMER USE ONLY

TITLE: TOP ASSEMBLY DRAWING
LOW Q CURRENT 100V,
2A BOOST/SEPIC/INVERTING CONVERTER

SIZE N/A	IC NO. LT8361EMSE DC2599A	REV. 2
-------------	---------------------------------	-----------

SHT 1 OF 2



 LINEAR TECHNOLOGY		1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
		TITLE: BOTTOM ASSEMBLY DRAWING LOW Q CURRENT 100V, 2A BOOST/SEPIC/INVERTING CONVERTER	
SIZE	IC NO.	LT8361EMSE	REV
N/A		DC2599A	2
			SHT 2 of 2